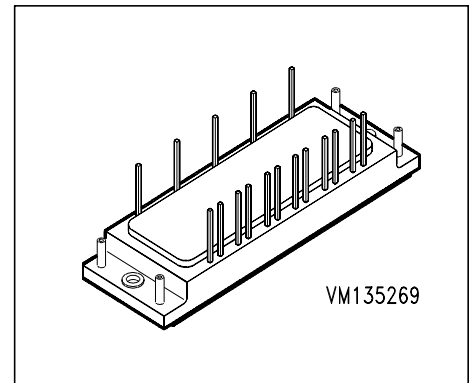


IGBT Power Module

- Power module
- 3-phase full-bridge
- Including fast free-wheel diodes
- Package with insulated metal base plate



Type	V_{CE}	I_C	Package	Ordering Code
BSM 10 GD 60 DN2	600V	10A	ECONOPACK 1	C67076-A2508-A67

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V_{CE}	600	V
Collector-gate voltage	V_{CGR}	600	
$R_{GE} = 20 \text{ k}\Omega$ Gate-emitter voltage	V_{GE}		
DC collector current	I_C	10	A
$T_C = 40 \text{ }^\circ\text{C}$ Pulsed collector current, $t_p = 1 \text{ ms}$	I_{Cpuls}		
Power dissipation per IGBT	P_{tot}	35	W
$T_C = 25 \text{ }^\circ\text{C}$ Chip temperature	T_j		
Storage temperature	T_{stg}	-55 ... + 150	$^\circ\text{C}$
Thermal resistance, chip case	R_{thJC}	≤ 3.5	
Diode thermal resistance, chip case	R_{thJCD}	≤ 4.5	K/W
Insulation test voltage, $t = 1 \text{ min.}$	V_{is}	2500	
Creepage distance	-	12	mm
Clearance	-	10	
DIN humidity category, DIN 40 040	-	F	sec
IEC climatic category, DIN IEC 68-1	-	40 / 125 / 56	

Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Gate threshold voltage $V_{GE} = V_{CE}, I_C = 0.35\text{ mA}$	$V_{GE(th)}$	4.5	5.5	6.5	V
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}, I_C = 10\text{ A}, T_j = 25\text{ °C}$	$V_{CE(sat)}$	-	2.1	2.7	
$V_{GE} = 15\text{ V}, I_C = 10\text{ A}, T_j = 125\text{ °C}$		-	2.2	2.8	
Zero gate voltage collector current $V_{CE} = 600\text{ V}, V_{GE} = 0\text{ V}, T_j = 25\text{ °C}$	I_{CES}	-	-	1	mA
Gate-emitter leakage current $V_{GE} = 25\text{ V}, V_{CE} = 0\text{ V}$	I_{GES}	-	-	100	nA

AC Characteristics

Transconductance $V_{CE} = 20\text{ V}, I_C = 10\text{ A}$	g_{fs}	3	-	-	S
Input capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	C_{iss}	-	570	-	pF
Output capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	C_{oss}	-	80	-	
Reverse transfer capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	C_{rss}	-	50	-	

Electrical Characteristics, at $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Switching Characteristics, Inductive Load at $T_j = 125\text{ °C}$

Turn-on delay time $V_{CC} = 300\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{Gon} = 100\ \Omega$	$t_{d(on)}$	-	40	80	ns
Rise time $V_{CC} = 300\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 10\text{ A}$ $R_{Gon} = 100\ \Omega$	t_r				nS
Turn-off delay time $V_{CC} = 300\text{ V}$, $V_{GE} = -15\text{ V}$, $I_C = 10\text{ A}$ $R_{Goff} = 100\ \Omega$	$t_{d(off)}$	-	250	370	ns
Fall time $V_{CC} = 300\text{ V}$, $V_{GE} = -15\text{ V}$, $I_C = 10\text{ A}$ $R_{Goff} = 100\ \Omega$	t_f				nS

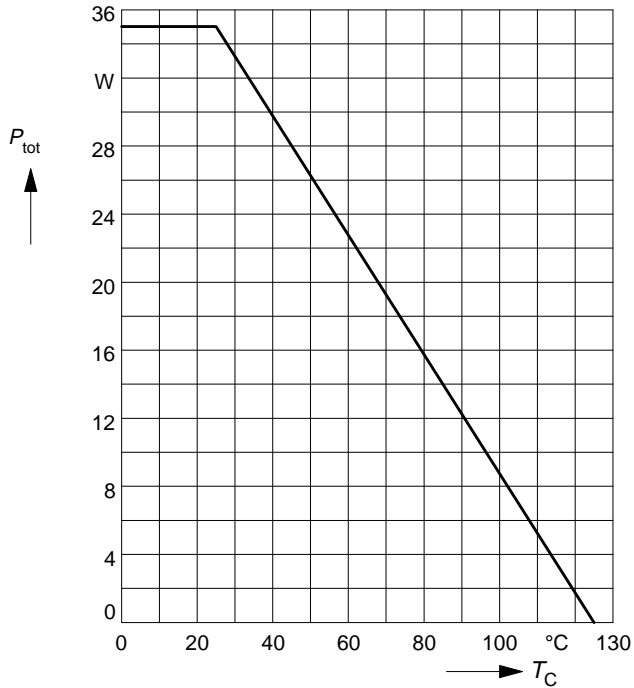
Free-Wheel Diode

Diode forward voltage $I_F = 10\text{ A}$, $V_{GE} = 0\text{ V}$, $T_j = 25\text{ °C}$ $I_F = 10\text{ A}$, $V_{GE} = 0\text{ V}$, $T_j = 125\text{ °C}$	V_F	-	1.6	-	V
Reverse recovery time $I_F = 10\text{ A}$, $V_R = -300\text{ V}$, $V_{GE} = 0\text{ V}$ $di_F/dt = -100\text{ A}/\mu\text{s}$, $T_j = 125\text{ °C}$	t_{rr}	-	0.1	-	μs
Reverse recovery charge $I_F = 10\text{ A}$, $V_R = -300\text{ V}$, $V_{GE} = 0\text{ V}$ $di_F/dt = -100\text{ A}/\mu\text{s}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	Q_{rr}	-	0.25	-	μC
		-	0.5	-	

Power dissipation

$$P_{\text{tot}} = f(T_C)$$

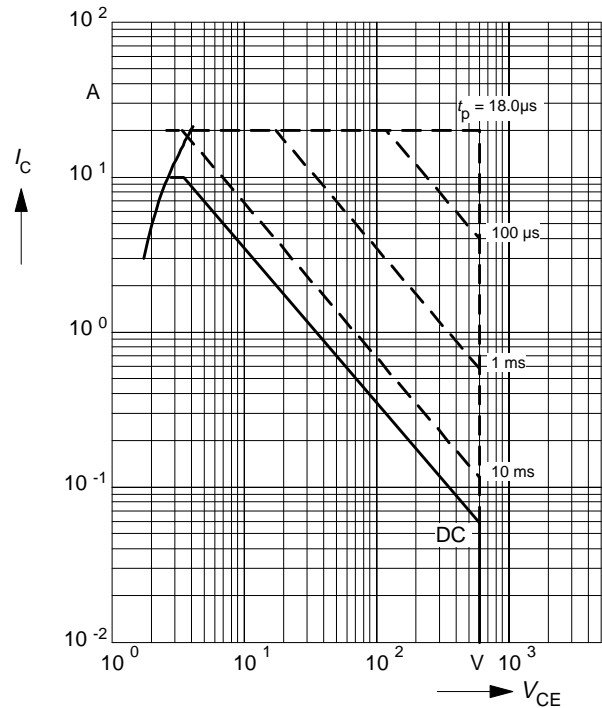
parameter: $T_j \leq 150^\circ\text{C}$



Safe operating area

$$I_C = f(V_{\text{CE}})$$

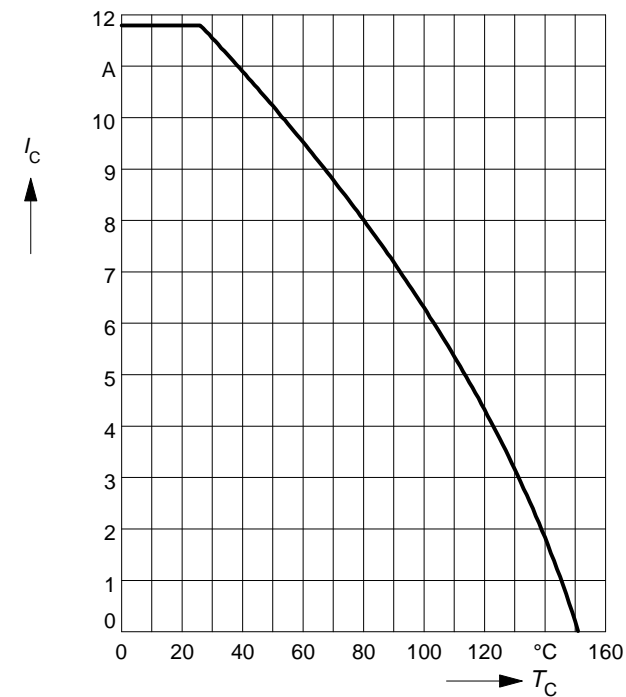
parameter: $D = 0, T_C = 25^\circ\text{C}, T_j \leq 150^\circ\text{C}$



Collector current

$$I_C = f(T_C)$$

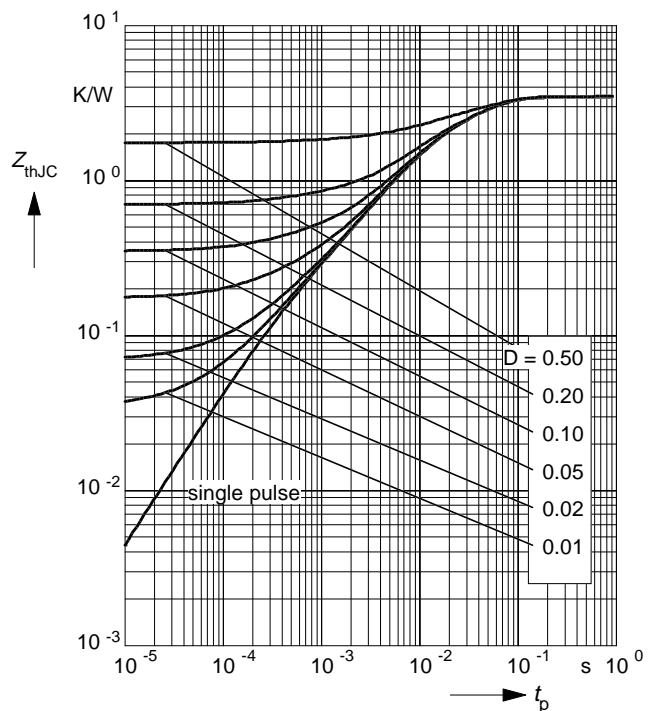
parameter: $V_{\text{GE}} \geq 15\text{V}, T_j \leq 150^\circ\text{C}$



Transient thermal impedance IGBT

$$Z_{\text{thJC}} = f(t_p)$$

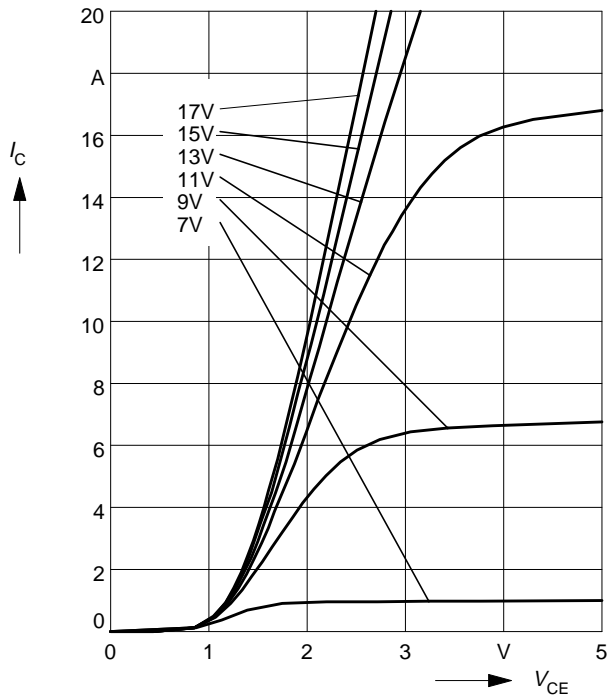
parameter: $D = t_p / T$



Typ. output characteristics

$$I_C = f(V_{CE})$$

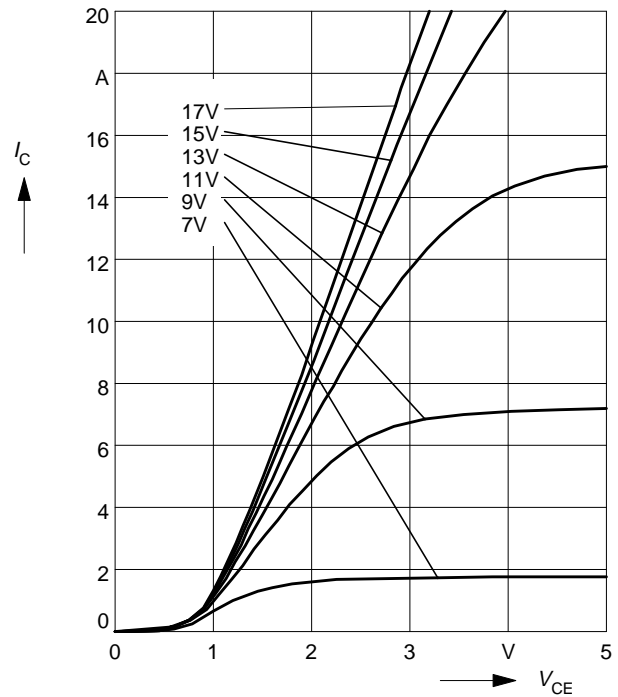
parameter: $t_p = 80 \mu s$, $T_j = 25 \text{ }^\circ\text{C}$



Typ. output characteristics

$$I_C = f(V_{CE})$$

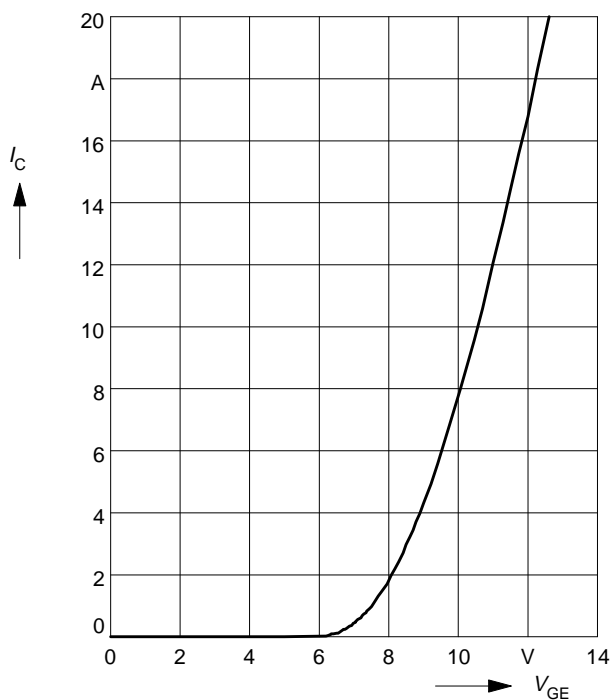
parameter: $t_p = 80 \mu s$, $T_j = 125 \text{ }^\circ\text{C}$



Typ. transfer characteristics

$$I_C = f(V_{GE})$$

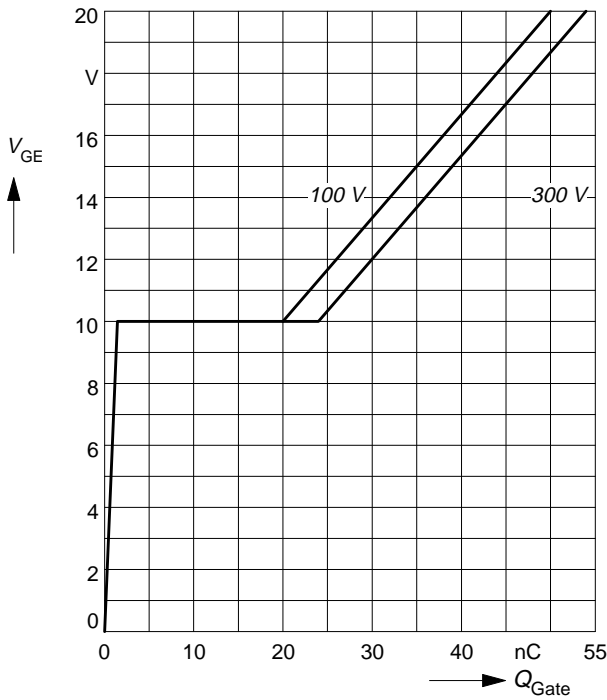
parameter: $t_p = 80 \mu s$, $V_{CE} = 20 \text{ V}$



Typ. gate charge

$$V_{GE} = f(Q_{Gate})$$

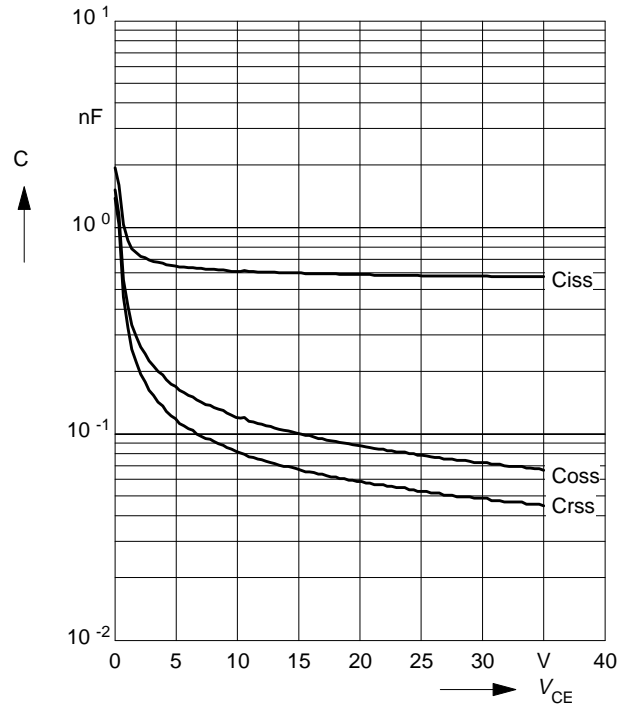
parameter: $I_{C\ puls} = 10\text{ A}$



Typ. capacitances

$$C = f(V_{CE})$$

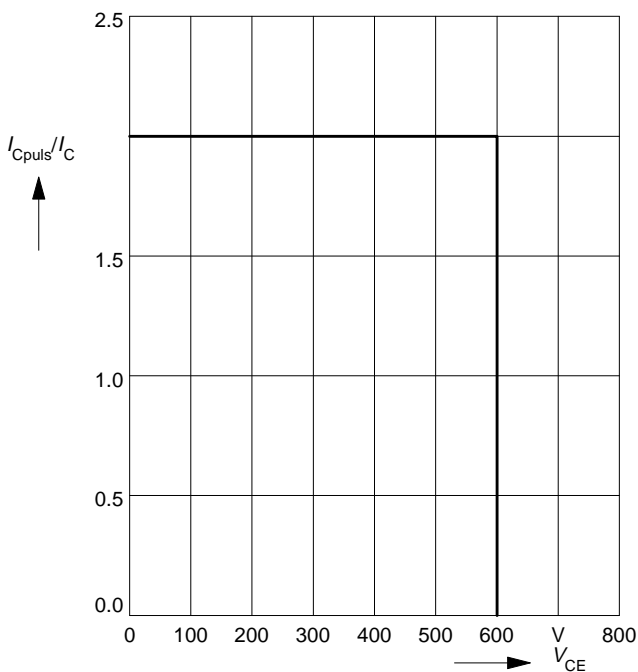
parameter: $V_{GE} = 0\text{ V}$, $f = 1\text{ MHz}$



Reverse biased safe operating area

$$I_{C\ puls} = f(V_{CE}), T_j = 150^\circ\text{C}$$

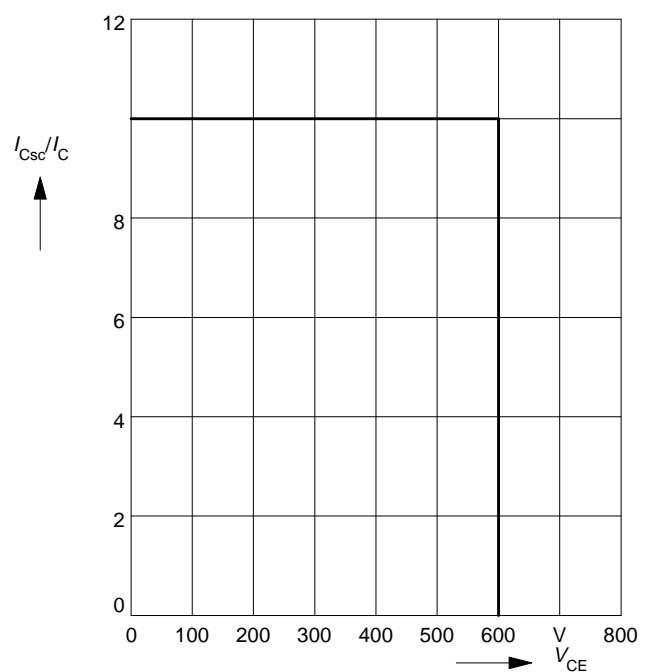
parameter: $V_{GE} = 15\text{ V}$



Short circuit safe operating area

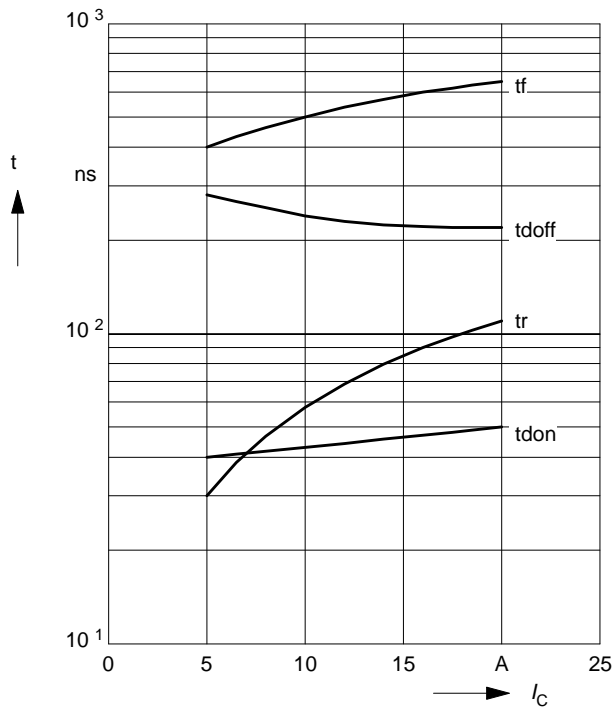
$$I_{C\ sc} = f(V_{CE}), T_j = 150^\circ\text{C}$$

parameter: $V_{GE} = \pm 15\text{ V}$, $t_{SC} \leq 10\ \mu\text{s}$, $L < 50\text{ nH}$



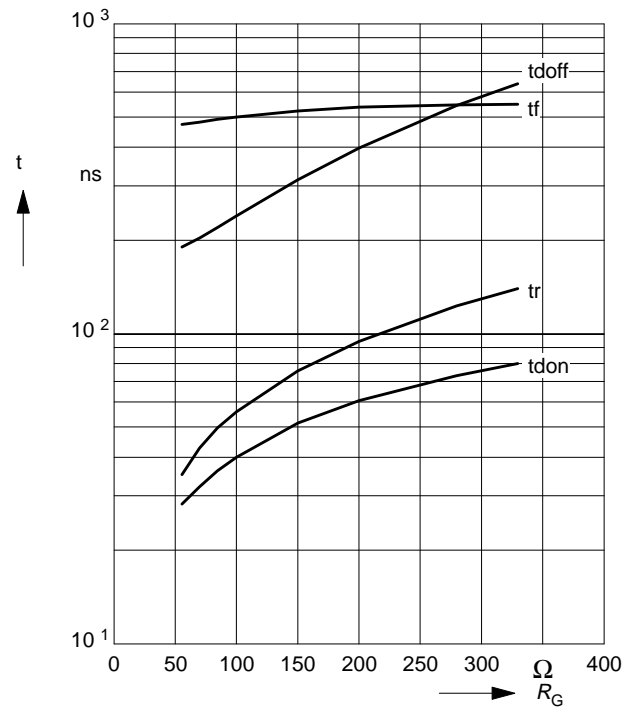
Typ. switching time

$t = f(I_C)$, inductive load, $T_j = 125^\circ\text{C}$
 par.: $V_{CE} = 300\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_G = 100\ \Omega$



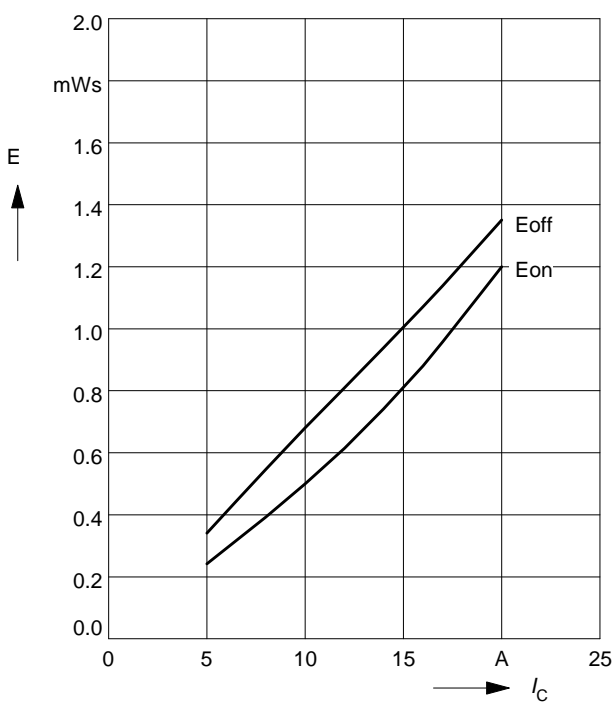
Typ. switching time

$t = f(R_G)$, inductive load, $T_j = 125^\circ\text{C}$
 par.: $V_{CE} = 300\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $I_C = 10\text{ A}$



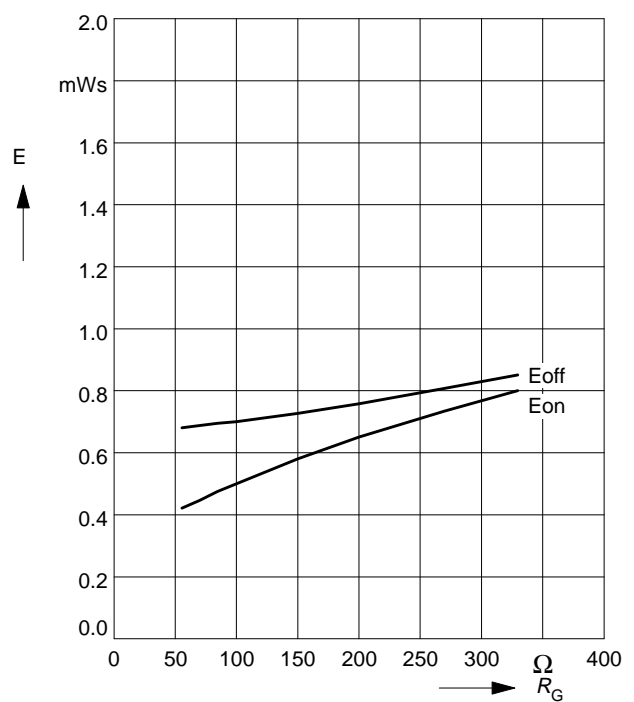
Typ. switching losses

$E = f(I_C)$, inductive load, $T_j = 125^\circ\text{C}$
 par.: $V_{CE} = 300\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_G = 100\ \Omega$



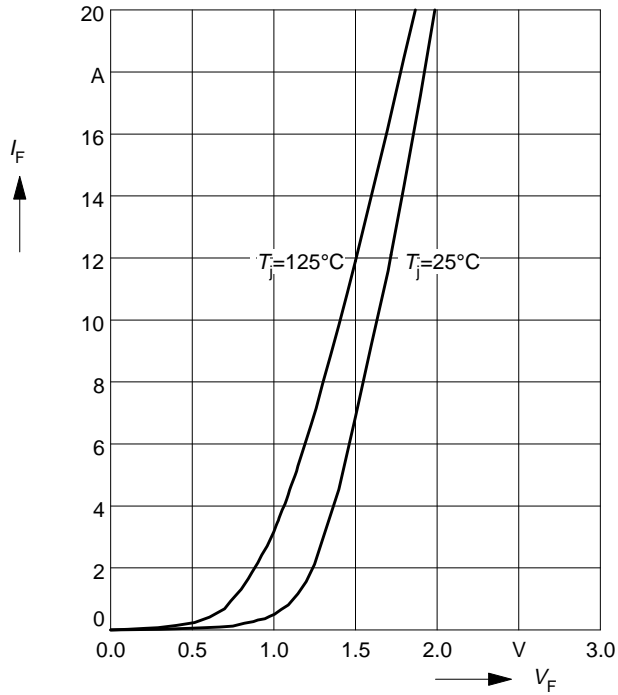
Typ. switching losses

$E = f(R_G)$, inductive load, $T_j = 125^\circ\text{C}$
 par.: $V_{CE} = 300\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $I_C = 10\text{ A}$



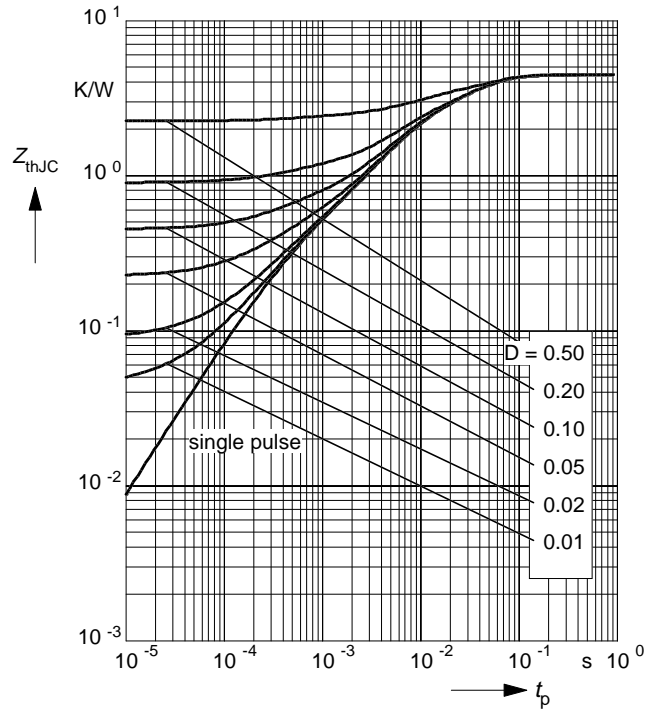
Forward characteristics of fast recovery reverse diode $I_F = f(V_F)$

parameter: T_j

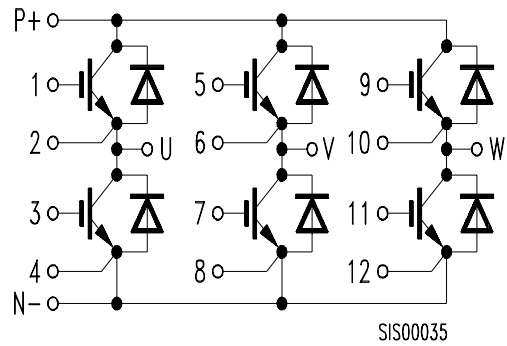


Transient thermal impedance Diode $Z_{thJC} = f(t_p)$

parameter: $D = t_p / T$



Circuit Diagram



Package Outlines

Dimensions in mm

Weight: 60 g

